

1589

Activated Rosin Liquid Flux

Product Description

Kester 1589 Activated Rosin Liquid Flux is a homogeneous solution of high quality, purified Grade WW rosin blended into an alcohol solvent system. A very effective activating agent has been added to provide superior fluxing ability. A very dilute formulation for applications where an absolute minimum of flux residue is desirable but high activity is required.

Kester 1589 has been developed for fluxing applications where non-activated and mildly activated rosin fluxes are too inactive to remove metal oxides, where proper and complete residue removal of potentially corrosive water-soluble organic acid flux is not possible, and where soldering of electronic assemblies requires instant wetting and excellent capillary flow. Kester 1589 can be used for solder coating or tinning bare leads.

Performance Characteristics:

- High thermal stability
- Improves soldering performance
- Classified as ROM1 per J-STD-004

RoHS Compliance

This product meets the requirements of the RoHS (Restriction of Hazardous Substances) Directive, 2002/95/EC Article 4 for the stated banned substances.

Physical Properties

Specific Gravity: 0.837 ± 0.005

Antoine Paar DMA 35 @ 25°C

Percent Solids (typical): 16

Tested to J-STD-004, IPC-TM-650, Method 2.3.34

Flash Point: 18°C (64°F)

Reliability Properties

Copper Mirror Corrosion: Moderate

Tested to J-STD-004, IPC-TM-650, Method 2.3.32

Corrosion Test: Low

Tested to J-STD-004, IPC-TM-650, Method 2.6.15

Silver Chromate: Fail

Tested to J-STD-004, IPC-TM-650, Method 2.3.33

Chloride and Bromides: 0.44%

Tested to J-STD-004, IPC-TM-650, Method 2.3.35

Fluorides by Spot Test: Pass

Tested to J-STD-004, IPC-TM-650, Method 2.3.35.1

Application Notes

Flux Application:

Kester 1589 Activated Rosin Flux can be applied by brush, dip, or wave processes.

Process Considerations:

The optimum preheat temperature for most circuit assemblies is 90-105°C (194-221°F) as measured on the top or component side of the printed circuit board. Dwell time in the wave is typically 2-4 seconds. The wave soldering speed should be adjusted to accomplish proper preheating and evaporate excess solvent, which could cause spattering. For best results, speeds of 1.1-1.8 m/min (3½-6 ft/min) are used. The surface tension has been adjusted to help the flux form a thin film on the board surface allowing rapid solvent evaporation.

Flux Control:

Specific gravity is normally the most reliable method to control the flux concentration of rosin-based fluxes. To check concentration, a hydrometer should be used. Kester 104 Thinner is an appropriate solvent for diluting this activated rosin flux to the desired solids content and viscosity, and for restoring solvent loss through evaporation.

Cleaning:

Kester 1589 flux residues are non-conductive, non-corrosive and do not require removal in most applications. If residue removal is required, call Kester Technical Support.

Storage and Shelf Life:

Kester 1589 is flammable. Store away from sources of ignition. Shelf life is 2 years from date of manufacture when handled properly and held at 10-25°C (50-77°F).

Health & Safety:

This product, during handling or use, may be hazardous to health or the environment. Read the Material Safety Data Sheet and warning label before using this product.

World Headquarters: 800 West Thorndale Avenue, Itasca, Illinois, 60143 USA
Phone: (+1) 847-297-1600 • **Email:** customerservice@kester.com • **Website:** www.kester.com

Asia Pacific Headquarters
 500 Chai Chee Lane
 Singapore 469024
 (+65) 6449-1133
 customerservice@kester.com.sg

European Headquarters
 Zum Plom 5
 08541 Neuensalz
 Germany
 (+49) 3741 4233-0customerservice@kester-eu.com

Japanese Headquarters
 20-11 Yokokawa 2-Chome
 Sumida-Ku
 Tokyo 130-0003 Japan
 (+81) 3-3624-5351
 jpsales@kester.com.sg
